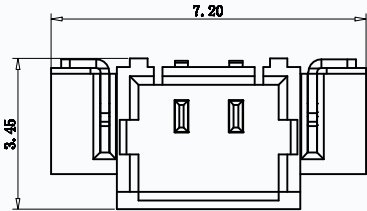
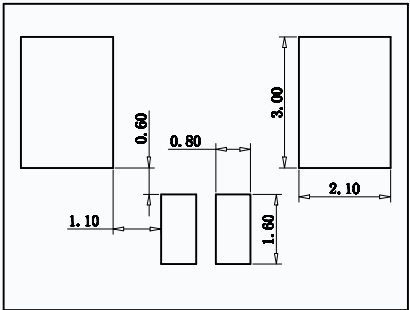


REV.	DESCRIPTION	APPD	DATE



NOTES:

- 1. MATERIAL:
 HOUSING: HIGH TEMPERATURE THERMOPLASTIC
 UL94V_0
 CONTACT: COPPER ALLOYS.
 COVER: COPPER ALLOYS OR STEEL.
- 2. PLATING:
 UNDERPLATE: NICKEL.
- 3. MULTIMEDIA CARD COMPATIBLE



PART NO:		MATERIAL:		CMTDDZ 东莞市田都科技有限公司 Dongguan TianDu Technology Co., Ltd.	
LOT NO:		FINISH:			
UNIT: MM	SIZE: A4	COLOR:		TITLE: 1.25间距 卧贴	
TOLERANCES:		DR: ERIC		DWG NO: T19-125LW 系列	
X.X=±0.35		CHK:		REV: A	
X.XX=±0.25		APP:		SCALE: 1:1	
X.XXX=±0.15		X.XX=±2.0°		SHEET: 1 OF 1	